

2SK741

Silicon N-Channel MOS FET

Application

High speed power switching

Features

- Low on-resistance
- High speed switching
- Low drive current
- No secondary breakdown
- Suitable for switching regulator, DC-DC converter and motor driver

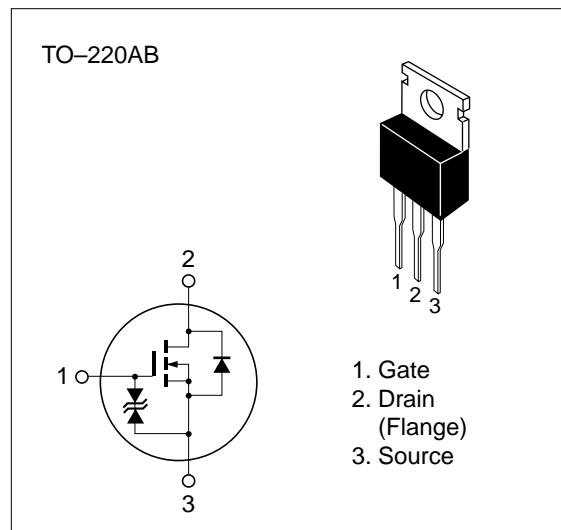


Table 1 Absolute Maximum Ratings (Ta = 25°C)

| Item | Symbol | Ratings | Unit |
|---|-------------------------|-------------|------|
| Drain to source voltage | V _{DSS} | 250 | V |
| Gate to source voltage | V _{GSS} | ±20 | V |
| Drain current | I _D | 7 | A |
| Drain peak current | I _{D(pulse)} * | 28 | A |
| Body to drain diode reverse drain current | I _{DR} | 7 | A |
| Channel dissipation | P _{ch} ** | 50 | W |
| Channel temperature | T _{ch} | 150 | °C |
| Storage temperature | T _{stg} | -55 to +150 | °C |

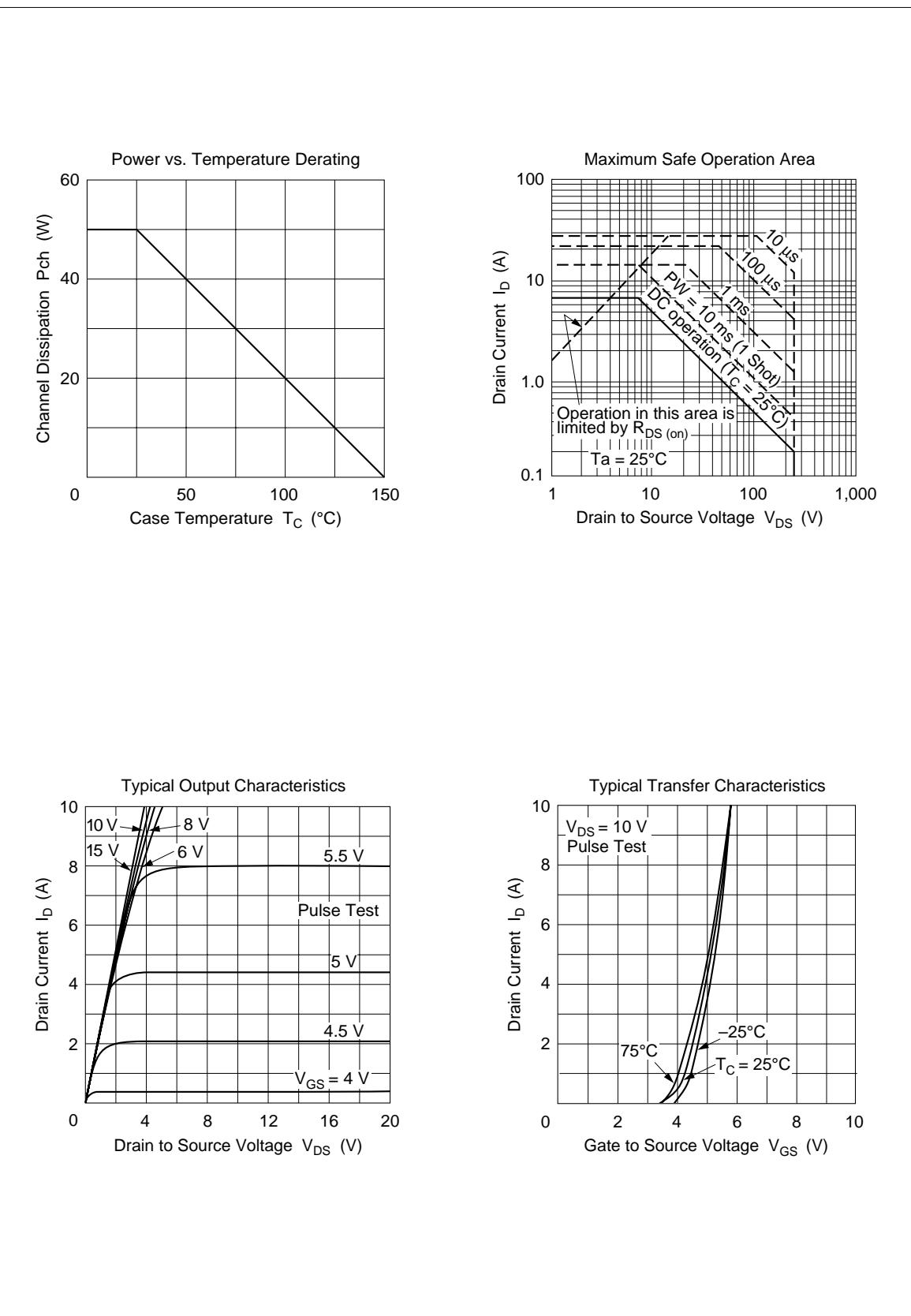
* PW ≤ 10 µs, duty cycle ≤ 1 %

** Value at T_C = 25 °C

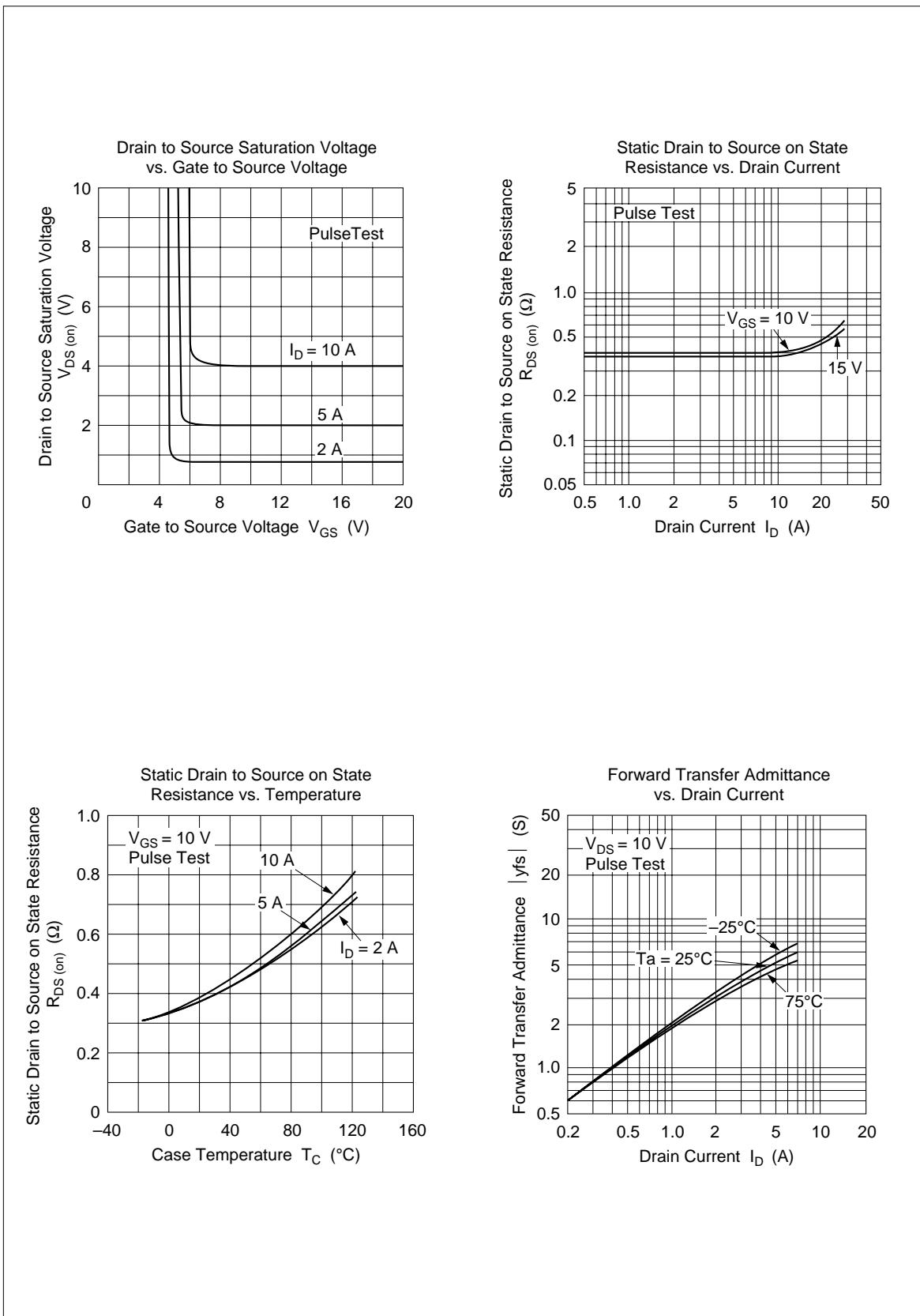
Table 2 Electrical Characteristics (Ta = 25°C)

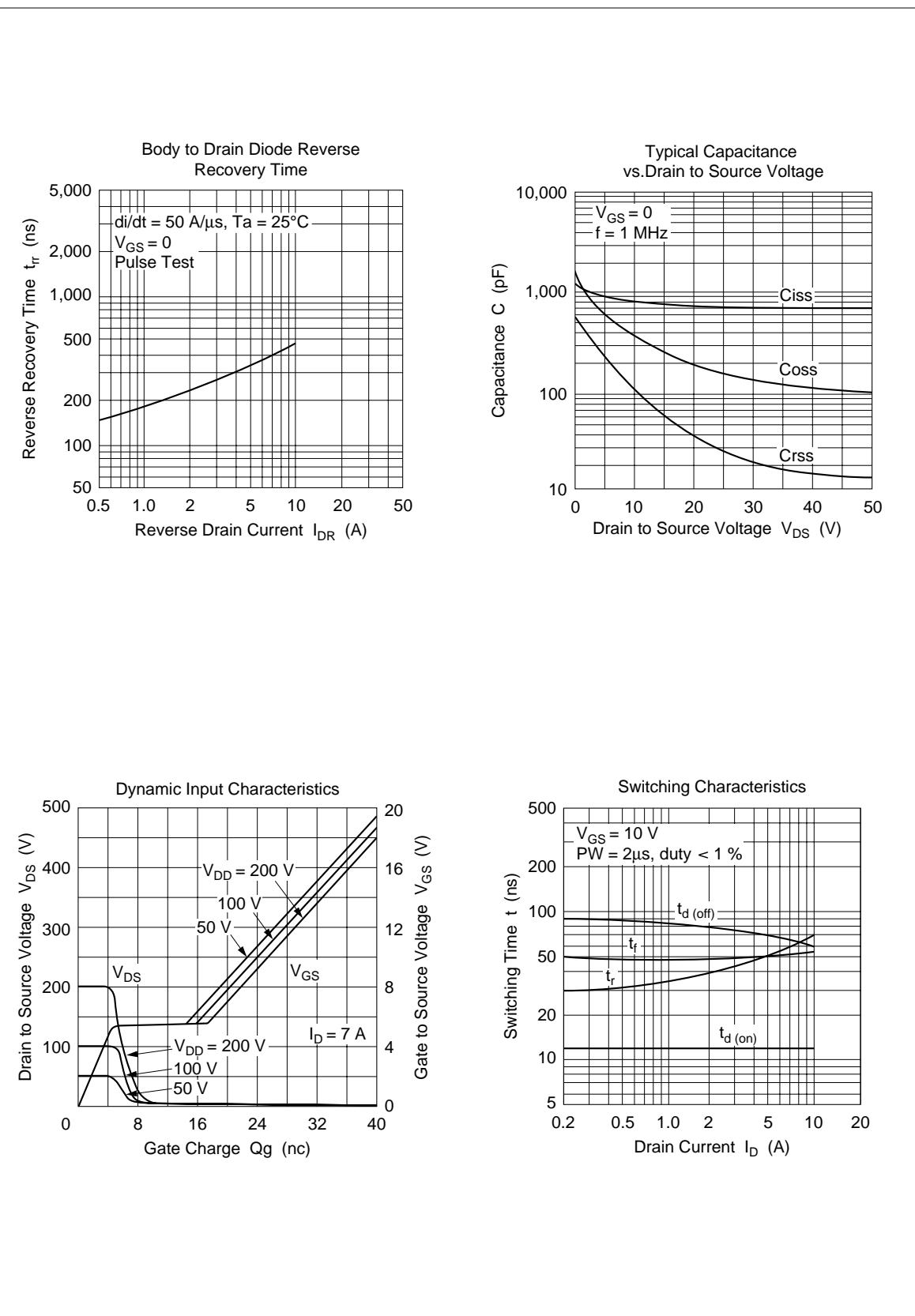
| Item | Symbol | Min | Typ | Max | Unit | Test conditions |
|--|----------------------|-----|------|------|------|---|
| Drain to source breakdown voltage | V _{(BR)DSS} | 250 | — | — | V | I _D = 10 mA, V _{GS} = 0 |
| Gate to source breakdown voltage | V _{(BR)GSS} | ±20 | — | — | V | I _G = ±100 µA, V _{DS} = 0 |
| Gate to source leak current | I _{GSS} | — | — | ±10 | µA | V _{GS} = ±16 V, V _{DS} = 0 |
| Zero gate voltage drain current | I _{DSS} | — | — | 250 | µA | V _{DS} = 200 V, V _{GS} = 0 |
| Gate to source cutoff voltage | V _{GS(off)} | 2.0 | — | 4.0 | V | I _D = 1 mA, V _{DS} = 10 V |
| Static drain to source on state resistance | R _{DS(on)} | — | 0.40 | 0.55 | Ω | I _D = 4 A, V _{GS} = 10 V * |
| Forward transfer admittance | y _{fs} | 2.7 | 4.5 | — | S | I _D = 4 A, V _{DS} = 10 V * |
| Input capacitance | C _{iss} | — | 820 | — | pF | V _{DS} = 10 V, V _{GS} = 0, |
| Output capacitance | C _{oss} | — | 370 | — | pF | f = 1 MHz |
| Reverse transfer capacitance | C _{rss} | — | 115 | — | pF | |
| Turn-on delay time | t _{d(on)} | — | 12 | — | ns | I _D = 4 A, V _{GS} = 10 V, |
| Rise time | t _r | — | 48 | — | ns | R _L = 7.5 Ω |
| Turn-off delay time | t _{d(off)} | — | 70 | — | ns | |
| Fall time | t _f | — | 50 | — | ns | |
| Body to drain diode forward voltage | V _{DF} | — | 1.2 | — | V | I _F = 7 A, V _{GS} = 0 |
| Body to drain diode reverse recovery time | t _{rr} | — | 400 | — | ns | I _F = 7 A, V _{GS} = 0, di _F /dt = 50 A/µs |

* Pulse Test

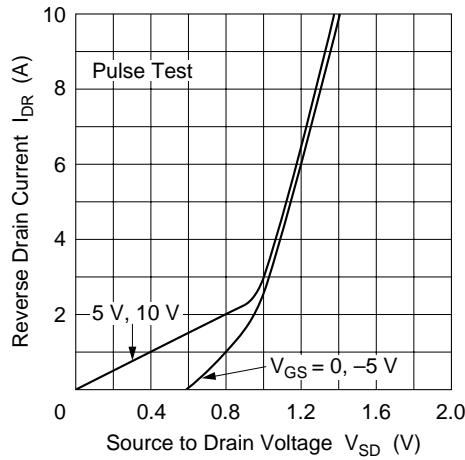


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Reverse Drain Current vs.
Source to Drain Voltage

Normalized Transient Thermal Impedance vs. Pulse Width

